

GaAs MMIC Monolithic Integrated 0 Degree Triple Power Divider , 12-15 GHz

Performance characteristics

- Frequency range: 12-15 GHz
- Insertion loss : 1.2 dB
- Isolation: 23 dB
- Amplitude imbalance : ± 0.1 dB
- 50Ohm input / output
- Chip size: QFN 4X4

Product Introduction

The GPD-12153-CQ4 monolithic integrated 0 -degree three-power divider has low insertion loss and good isolation in the frequency range of 12 ~ 15 GHz , and is very suitable for microwave hybrid integrated circuits and multi-chip modules. This chip adopts a 4 x 4 mm ceramic surface mount package, and the surface of the pin pad is tinned, which is suitable for reflow soldering installation process.

Use restriction parameter ¹	
Maximum input power	+40dBm
Operating temperature	-55 ~ +85°C
Storage temperature	-65 ~ +150°C

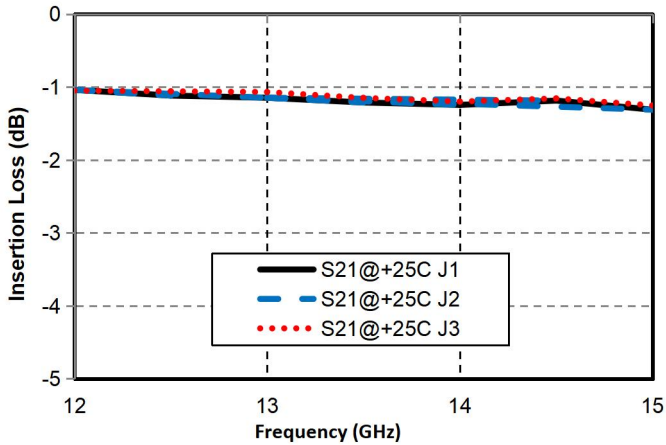
【1】 Exceeding any of these maximum limits may cause permanent damage.

Electrical performance parameters (TA = +25°C)				
Index	Minimum	Typical Value	Maximum	Unit
Frequency Range	12-15			GHz
Insertion loss	-	1.2	-	dB
Insertion loss fluctuation	-	0.3	-	dB
Isolation	-	23	-	dB
Amplitude imbalance	-	± 0.1	-	dB
Input return loss	-	20	-	dB
Output return loss	-	12	-	dB

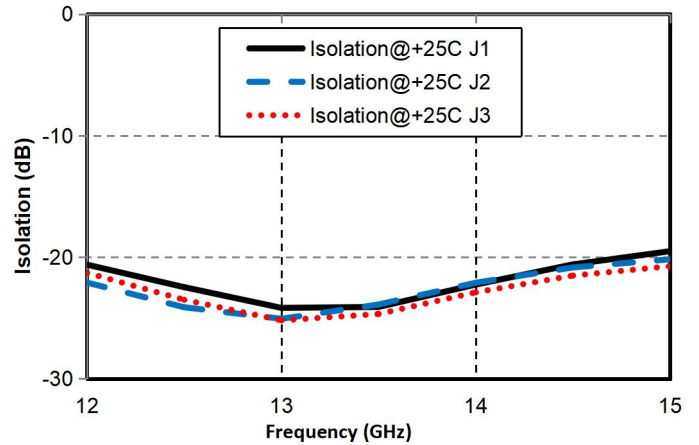
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Main index test curve

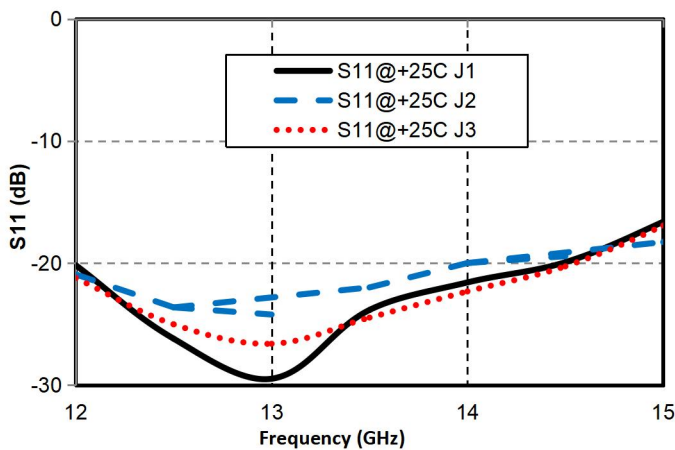
Insertion Loss vs. Operating Frequency



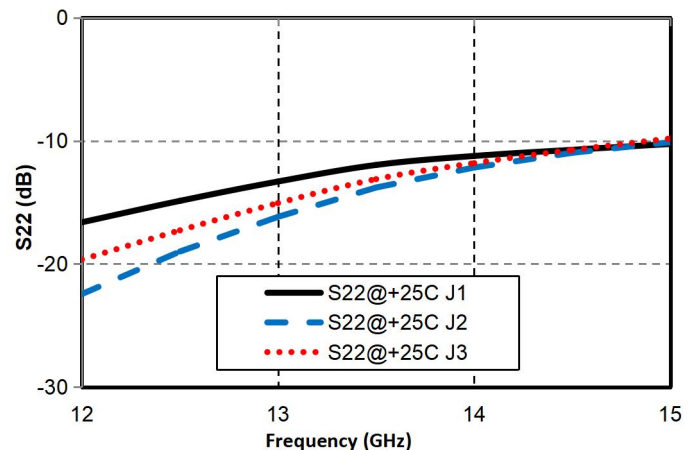
Isolation vs. Operating Frequency



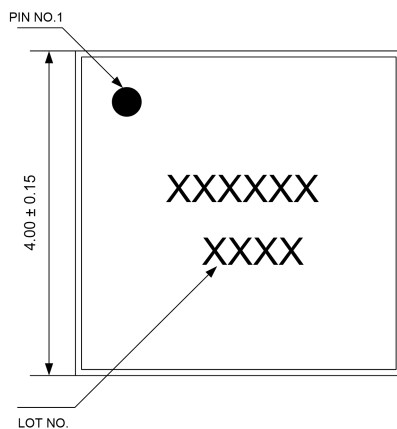
Input Return Loss vs. Operating Frequency



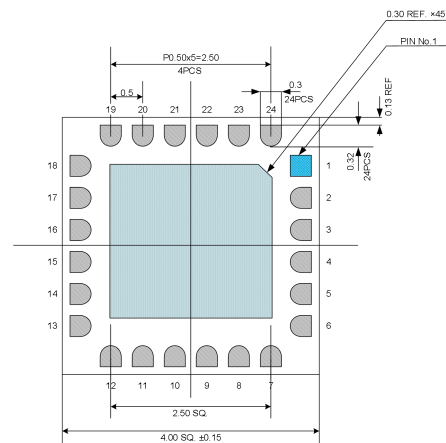
Output Return Loss vs. Operating Frequency



Appearance structure



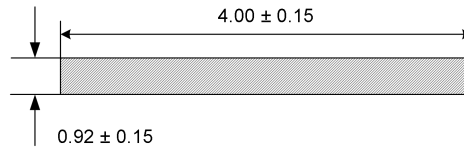
Top view



Bottom view

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Appearance structure

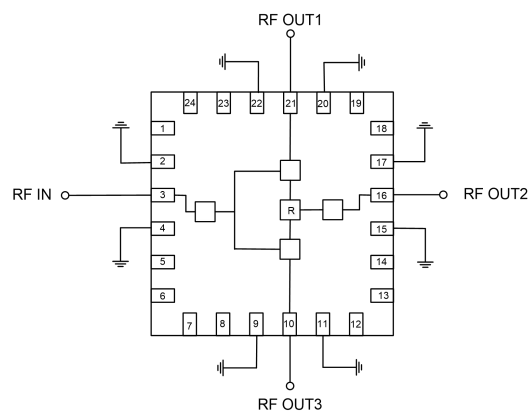


Side View

All units in the figures are millimeters .

Pin Definition		
Bonding point number	Function Symbol	Functional Description
3	RFIN	RF signal input terminal
10, 16 , 21	RFOUT	RF signal output terminal
11 , 15 , 17 , 20, 22	GND	The pins need to be well grounded to the RF and DC grounds
Chip bottom	GND	The bottom of the chip needs to be well grounded to RF and DC
Other	NC	The pin is floating and can be grounded

Recommended Circuit



Precautions for use

- Sealing material : Ceramic material that meets ROHS standards
- Lead surface plating: gold, gold layer thickness greater than 1.5um
- Maximum reflow peak temperature: 260 °C